



ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.:	SPCI011I
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1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment

EIA - 364 Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CI35 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings

REVIEWED: <u>Eisley</u> APPROVED: <u>Sun</u> VERIFIED: <u>Michelle</u>.





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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		3A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than $20 \text{ m}\Omega$
7.3	Dielectric strength	When applied AC 1000 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than $1000 \text{ M}\Omega$

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Wire size	Specified wire size	Accepts AWG#22~#28
8.2	Terminal crimp Tensile	When crimped AWG#22 size wire	More than 5.0 Kgf
	strength	When crimped AWG#24 size wire	More than 3.0 Kgf
		When crimped AWG#26 size wire	More than 2.0 Kgf
		When crimped AWG#28 size wire	More than 1.3 Kgf
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 1.0 Kgf
8.4	Contact retaining force in insulator	Retention speed 25± 3 mm per minute from housing	More than 2.5 Kgf
8.5	Single contact insertion force	Measure force to insertion using 0.64 mm square pin at speed 25± 3 mm per minute	1.0 Kgf max.
8.6	Single contact withdrawal force	Measure force to withdrawal using 0.64 mm square pin at speed 25± 3 mm per minute	200 gram min.
8.7	Mating force	Mating connector & header W/O latch, speed 25± 3 mm per minute	4.0 Kgf max.
8.8	Unmating force	Unmating connector & header W/O latch, speed 25± 3 mm per minute	0.8 Kgf min.
8.9	Durability	Connector shall be subjected to 30 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial
8.10	Pin retention force	Push pin from insulator base at speed 25± 3 mm per minute	More than 1.5 Kgf

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ / minute each 2 hours for X, Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.





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	ITEM	TEST CONDITION	REQUIREMENT
9.3	Solder ability	Tin-Lead Process:	Minimum:
		Soldering time: 5 ± 0.5 second	90% of immersed area
		Soldering pot: 230 ± 5 °C	
9.4	Resistance to	Tin-Lead Process:	No damage
	soldering heat	Soldering time: 5 ± 0.5 second	
		Soldering pot: 240 ± 5 °C	
9.5	Heat aging	85 ± 2°C , 96 hours	No damage
9.6	Humidity	40 ± 2 °C , 90-95% RH , 96 hours	Appearance: No damage
		measurement must be taken within 30 min.	Contact resistance:
		after tested	Less than twice of initial
			Dielectric strength:
0.7			To pass para 7-3
9.7	Temperature cycling	One cycle consists of:	Appearance: No damage
		(1) $-55 + 0 - 3$ °C, 30 min.	Contact resistance:
		(2) Room temp. 10-15 min.	Less than twice of initial
		(3) 85^{+3}_{-0} °C, 30 min.	
		(4)Room temp. 10-15 min.	
9.8	Salt spray	Temperature: 35 ± 3 °C	Appearance: No damage
		Solution: 5 ± 1%	Contact resistance:
		Spray time: 48 ± 4 hours	Less than twice of initial
		(Stamping before plated)	
		Spray time: 24 ± 4 hours	
		(Stamping after plated)	
		Mate connectors and expose to the following	
		salt mist conditions. Upon completion of the exposure period, salt deposits shall be	
		removed by a gentle wash or dip in running	
		water and dried naturally, after which the	
		specified measurements shall be performed.	
		The specimens shall be suspended from the top using waxed twine, string or nylon thread.	
		The test only define the plating area, without plating area (as copper cross section) will not be defined.	
		(EIA 364-26B / MIL-STD-202 Method 101)	

10. AMBIENT TEMPERATURE RANGE: -25 to +85°C